

RECORDATION FORM COVER

MRD 8-19-98
PATENTS ONLY

09-11-1998



100825679

To the Honorable Commissioner of Patents and Trademarks:
documents or copy thereof.

Submitted Original

1. Name of Conveying party(ies): Mark Hoinkis, Stefan J. Weber

3. Nature of Conveyance: Assignment

2. Name & address of receiving party(ies)

Name: Siemens Microelectronics Inc.

Street

Address: 10950 North Tantau Avenue

City: Cupertino State: California

Zip: 95014

Execution Date: 8/3/98, 8/18/98

4. Application number(s) or patent number(s): 09/105,644

Title of Application: CVD/PVD METHOD OF FILLING STRUCTURES USING DISCONTINUOUS CVD AL
LINERIf this document is being filed together with a new application, the execution date of
the application is: 8/3/98, 8/18/98

A. Patent Application No(s).

Docket No. HQ9-98-053

B. Patent No(s)

Additional numbers attached? ☐ Yes ☒ No5. Name and address of party to whom
correspondence concerning document

should be mailed:

Name: Elsa Keller

Street Address:

Siemens Corporation
Intellectual Property Department
186 Wood Avenue South
Iselin, New Jersey 088306. Total number of applications and
patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00

Enclosed

☒ Authorized to be charged to
deposit account8. Deposit A/C no.: 09-0458 (FI-371)
(Attach duplicate copy of this page
if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement of signature:

To the best of my knowledge and belief, the foregoing information is true and correct
and any attached copy is a true copy of the original document.

Steven Capella, Registration No. 33,086

Name of Person Signing

Telephone No. (914) 894-3669

Signature

Date

Total number of pages including cover sheet, attachments, and document: 5

I HEREBY CERTIFY THAT THIS CORRESPONDENCE IS BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE AS FIRST
CLASS MAIL IN AN ENVELOPE ADDRESSED TO: COMMISSIONER OF PATENTS AND TRADEMARKS, WASHINGTON, D.C. 20231. THE
APPLICANT AND/OR ATTORNEY REQUEST THE DATE OF DEPOSIT AS THE FILING DATE.

Date of Deposit:

August 19, 1998

Name of Person Making Deposit: RobinAnn Zeno

Signature:

RobinAnn Zeno 8/19/98

ASSIGNMENT

For good and valuable consideration, I, Mark Hoinkis, residing at 37 Spruce Ridge Drive, Fishkill, New York 12524, a citizen of USA,

Hereby sell, assign and transfer to **Siemens Microelectronics, Inc.**, a corporation organized and existing under the laws of the state of Delaware, having its principal place of business at **10950 North Tantau Avenue, Cupertino, California, 95014**, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith, and is entitled:

CVD/PVD METHOD OF FILLING STRUCTURES USING DISCONTINUOUS CVD AL LINER

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its

successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

| | |
|---------------------|---------------|
| <u>Mark Hoinkis</u> | <u>8/3/98</u> |
| Mark Hoinkis | Date |

ASSIGNMENT

For good and valuable consideration, I, Stefan J. Weber, residing at 26 Tamarack Circle, Fishkill, New York 12524, a citizen of Germany,

Hereby sell, assign and transfer to **Siemens Microelectronics, Inc.**, a corporation organized and existing under the laws of the state of Delaware, having its principal place of business at **10950 North Tantau Avenue, Cupertino, California, 95014**, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith, and is entitled:

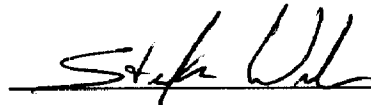
CVD/PVD METHOD OF FILLING STRUCTURES USING DISCONTINUOUS CVD AL LINER

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its

successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.



Stefan J. Weber

8/18/98

Date